



RUI SHUO

深圳市锐硕光电有限公司

Shenzhen Ruishuo Optoelectronic Co.,Ltd

SPECIFICATIONS FOR T56 SERIES

WHITE LED

Model : 5630

Part No : T56xxx12x-Mxxxxxx

Features:

- * Top view white LED
- * Thermally Enhanced Package Design
- * High luminous flux output
- * High current capability
- * Compact Package Size
- * Wide viewing angle
- * Pb-free Reflow Soldering Application
- * The product itself will remain within RoHS compliant version

**Applications**

- * Interior lighting
- * Retrofits (replacement)
- * General lighting
- * Architectural / Decorative lighting

Part Numbering System

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X1 X2 X3 X4 X5 X6 X7 X8 X9 X10

Item Number Code	Description	Content
X1	Type code	1S:1010; 1A:1919; 20:2016; 3B:3014; 28:2835 34:3020; 3C:3030; 5C:5050; 7C:7070; 1D:100100; 19:Ceramic 3535; 15:Ceramic 5050; 11:Ceramic 1616.
X2	CCT code	2700K:27; 3000K:30; 4000K:40; 5000K:50; 5700K:57; 6500K:65.
X3	Color Rendering	Ra70:7; Ra80:8; Ra90:9.
X4	No. of serial chip	1-Z.
X5	No. of parallel chip	1-Z.
X6	Component code	A-Z.
X7	Color Code	M:ANSI; F:ERP; R:85°C ANSI; T:105°C ANSI; B:Backlighting; Q:Others;
X8	Internal code1	\
X9	Internal code2	\
X10	Spare code	\

Electro Optical Characteristics, IF = 65mA

CCT	Color Rendering	Luminous Flux	
		Ta=25°C	
	Min.	Typ.	Min.
2700K	70	34.0	32.0
	80	32.0	30.0
	90	26.5	25.0
3000K	70	36.0	34.0
	80	34.0	32.0
	90	28.0	27.0
4000K	70	38.0	36.0
	80	36.0	34.0
	90	29.5	28.0
5000K	70	38.0	36.0
	80	36.0	34.0
	90	29.5	28.0
5700K	70	38.0	36.0
	80	36.0	34.0
	90	29.5	28.0
6500K	70	38.0	36.0
	80	36.0	34.0
	90	29.5	28.0

* Tolerance of measurements of the Luminous Flux is $\pm 7\%$.

* Ra measurement tolerance is ± 2 .

* Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Absolute Maximum Ratings at Ta=25°C

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	IF	240	mA
Pulse Forward current	IFP	280	mA
Power Dissipation	PD	720	mW
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C
Junction Temperature	Tj	125	°C
Soldering Temperature	Tsld	Reflow Soldering : 230°C or 260°C for 10sec	

* IFP condition with Pulse: Width≤100μs, Duty cycle≤1/10.

* LED's properties might be different from suggested values like above and below tables if operation condition will be exceeded our parameter range. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

* All measurements were made under the standardized environment of Lightning LED.

Electrical/Optical Characteristics at Ta=25°C

Item	Symbol	Min	Typ	Max	Unit	Condition
Forward Voltage	VF	2.6	-	3.2	V	IF=65mA
Reverse Current	IR	-	-	10	μA	VR=5V
Luminous Flux	ΦV	25.0	36.0		lm	IF=65mA
View Angle	2θ _{1/2}	-	120	-	°	IF=65mA
Correlated Color Temperature	CCT	2700	4000	6500	K	IF=65mA
Color Rendering Index	Ra	70	80	90	-	IF=65mA
Color Rendering Index	R9	-	-	-	-	IF=65mA
Characteristics Coordinates	X	-	0.3825	-	-	IF=65mA
	y	-	0.3798	-	-	IF=65mA
Thermal resistance	(Rth j-sp)	-	10	-	°C/W	IF=65mA
Electrostatic Discharge	ESD	1000	-	-	V	HBM

* Tolerance of measurements of the Forward Voltage is ±0.1V.

* Tolerance of measurements of the Luminous Flux is ±7%.

* 2θ_{1/2} is the off-axis where the luminous intensity is 1/2 of the peak intensity.

* Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

* Ra measurement tolerance is ±2.

* R9 measurement tolerance is ±6.5.

* Tolerance of measurements of the chromaticity Coordinate is ±0.005.

* Rth j-sp is the thermal resistance from LED junction to solder point on MCPCB with electrical power.

Bin Structure

Luminous Flux Ranks, IF = 65mA, Ta =25°C

CCT	Color Rendering		Luminous Flux		
	Min.	Typ.	Code	Min	Max
2700K	70	72	D9	32	34
			E1	34	36
			E2	36	38
	80	82	D8	30	32
			D9	32	34
			E1	34	36
	90	92	D5	24	26
			D6	26	28
			D7	28	30
3000K	70	72	E1	34	36
			E2	36	38
			E3	38	42
	80	82	D9	32	34
			E1	34	36
			E2	36	38
	90	92	D6	26	28
			D7	28	30
			D8	30	32
4000K 5000K 5700K 6500K	70	72	E1	34	36
			E2	36	38
			E3	38	42
	80	82	E1	34	36
			E2	36	38
			E3	38	42
	90	92	D7	28	30
			D8	30	32
			D9	32	34

* Tolerance of measurements of the Luminous Flux is $\pm 7\%$.

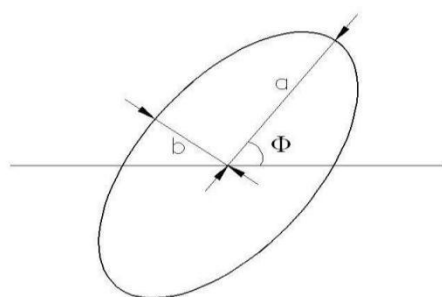
* Ra measurement tolerance is ± 2 .

Forward Voltage Ranks, IF = 65mA, Ta =25°C

Code	Min	Max	Unit
Z1	2.6	2.7	V
A1	2.7	2.8	V
B1	2.8	2.9	V
C1	2.9	3.0	V
D1	3.0	3.1	V
E1	3.1	3.2	V

* Tolerance of measurements of the Forward Voltage is $\pm 0.1V$.

CIE Chromaticity Diagram, IF = 65mA, Ta = 25°C



The color ranks have chromaticity ranges within 5-step MacAdam ellipse

Color Code	Center		Radius		Angle(deg)
	x	y	a	b	Φ
27M5	0.4582	0.4099	0.013500	0.00700	53.42
30M5	0.4342	0.4028	0.013900	0.00680	53.13
40M5	0.3825	0.3798	0.015650	0.00670	53.43
50M5	0.3451	0.3554	0.013700	0.00590	59.37
57M5	0.3290	0.3417	0.011175	0.00550	58.35
65M5	0.3130	0.3290	0.011150	0.00475	58.34

* Energy Star binning applied to all 2600~7000K.

* Tolerance of measurements of the chromaticity Coordinate is ± 0.005 .

Fig 1. Color Spectrum, Ta = 25°C

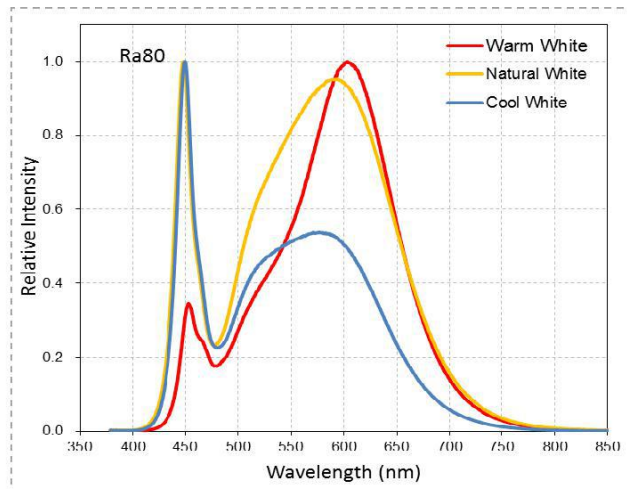
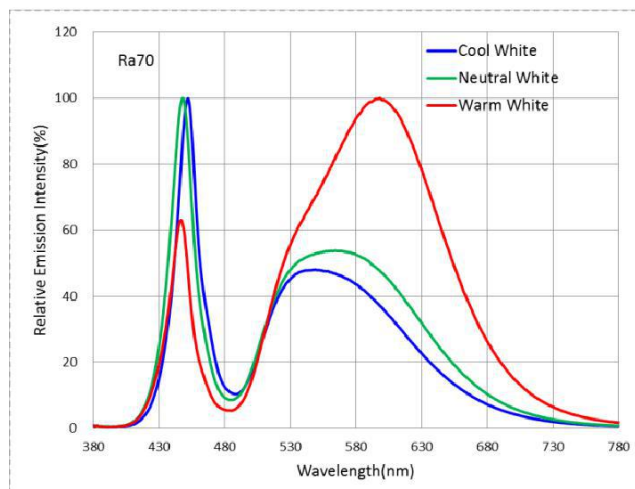


Fig 2. Viewing Angle Distribution, Ta = 25°C

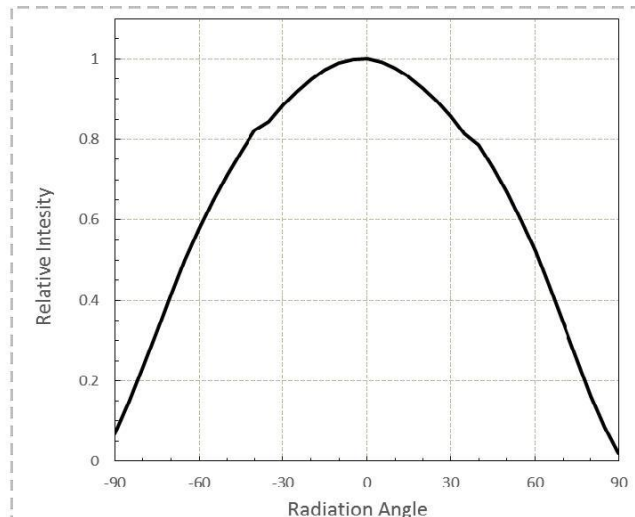
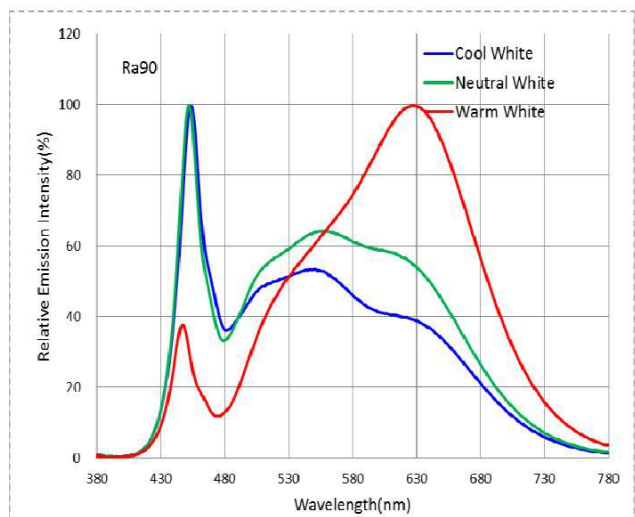


Fig 3. Forward Current vs. Relative Intensity, Ta = 25°C

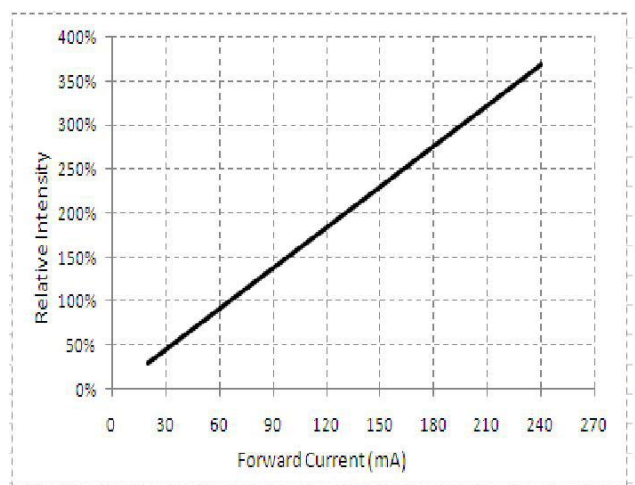
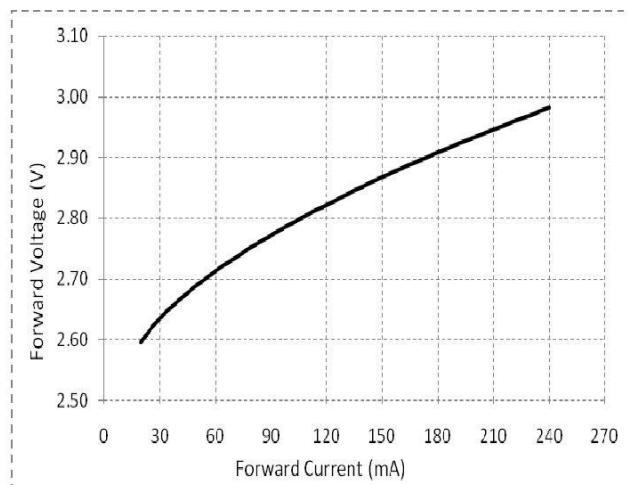
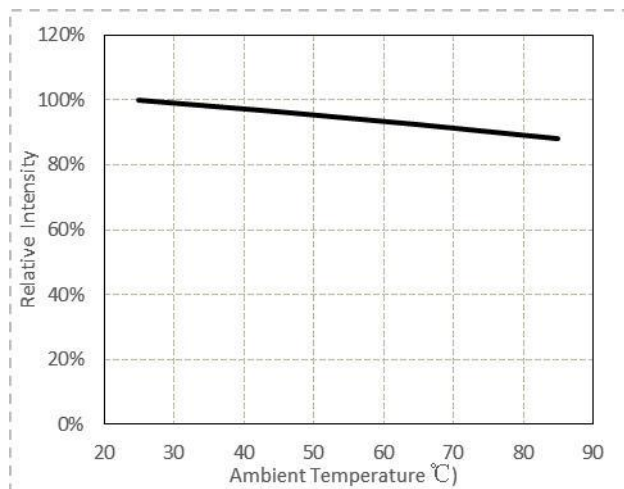


Fig 4. Forward Current vs. Forward Voltage, Ta = 25°C



**Fig 5. Ambient Temperature vs. Relative Luminous flux
(IF=65mA)**



**Fig 6. Ambient Temperature vs. Relative Forward Voltage
(IF=65mA)**

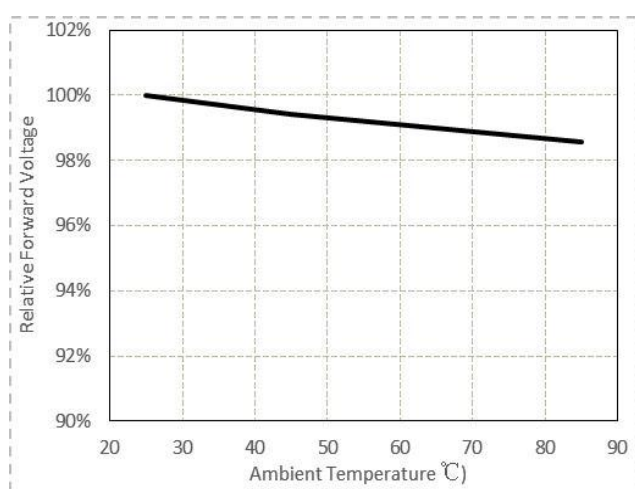
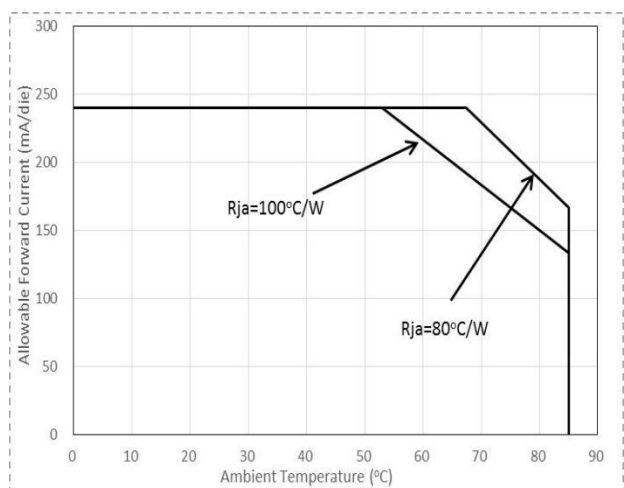
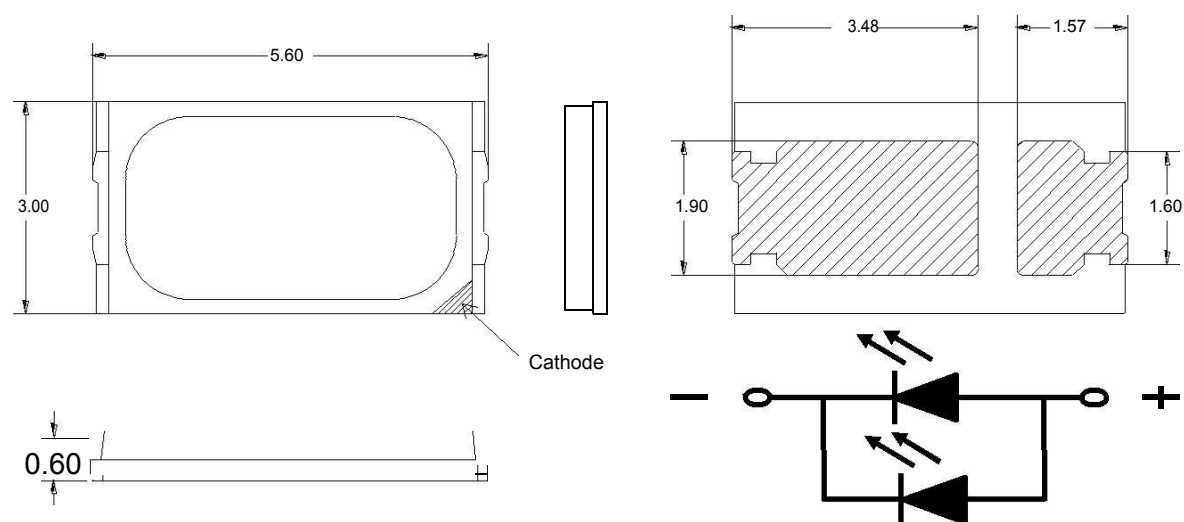


Fig 7. Allowable Forward Current vs. Ambient Temperature

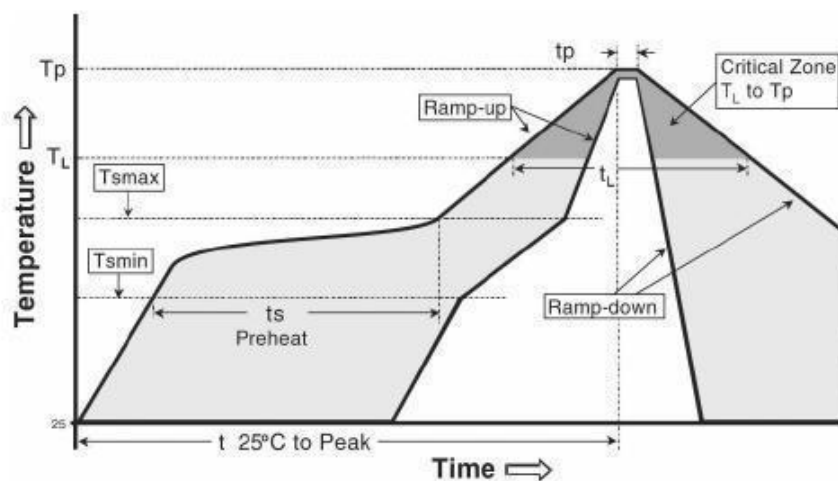


Package Dimensions



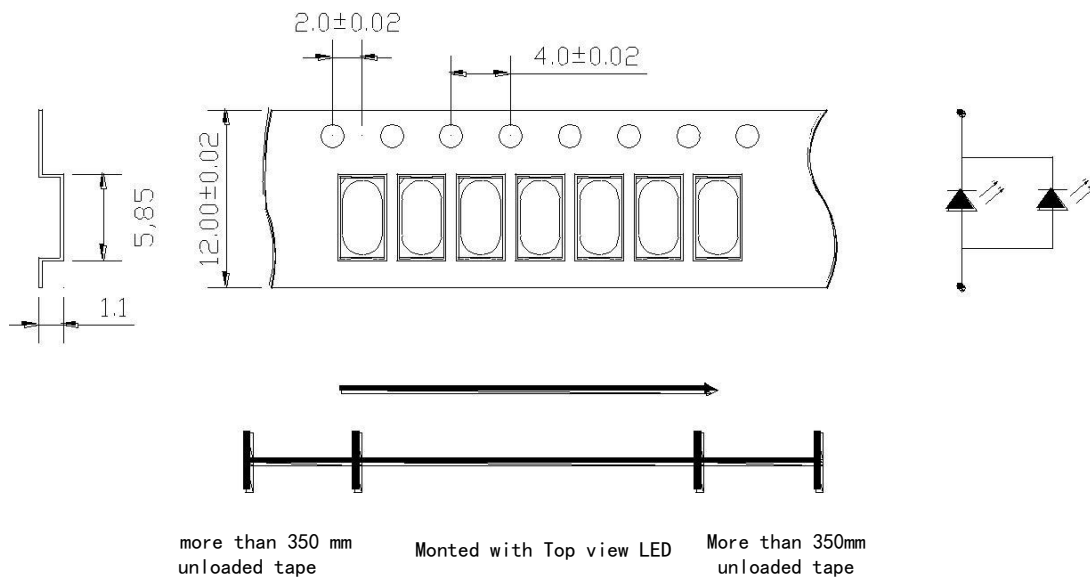
* The tolerance unless mentioned is $\pm 0.1\text{mm}$, unit = mm

Reflow Soldering Characteristics



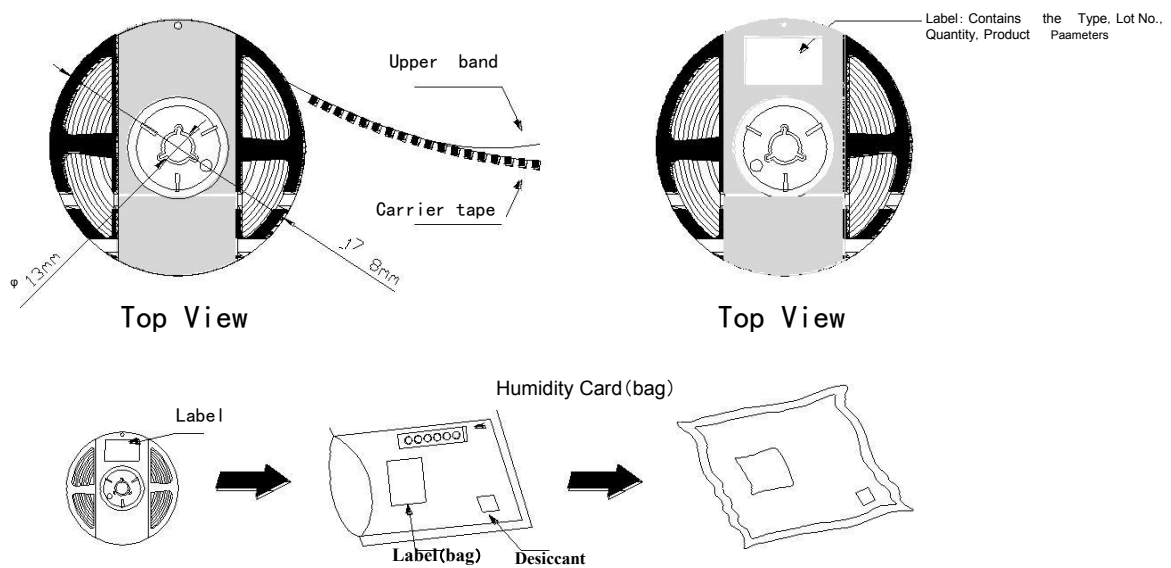
Reflow soldering	
Temperature Min (T _{smin})	150° C
Temperature Max (T _{smax})	200° C
Time(t _s)from (T _{smin} to T _{smax})	60-120 seconds.
Ramp-up rate (T _L to T _p)	3° C/seconds max.
Liquidous temperature(T _L)	217° C
Time(t _L) maintained above T _L	60-150 seconds
Peak package body temperature(T _p)	260° C max
Time (t _p) within 5° C of the specified classification temperature (T _c).	30 seconds max
Ramp-down rate (T _p to T _L)	6° C/second max
Time 25 ° C to peak temperature	8 min max

Package Dimensions of Tape

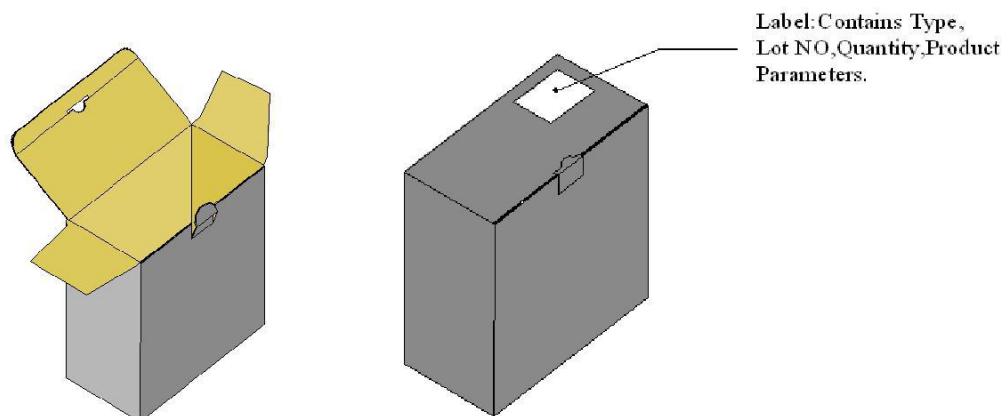


- * Quantity : Max 4000pcs/Reel
- * Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$
- * Package : P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package.
- * unit = mm

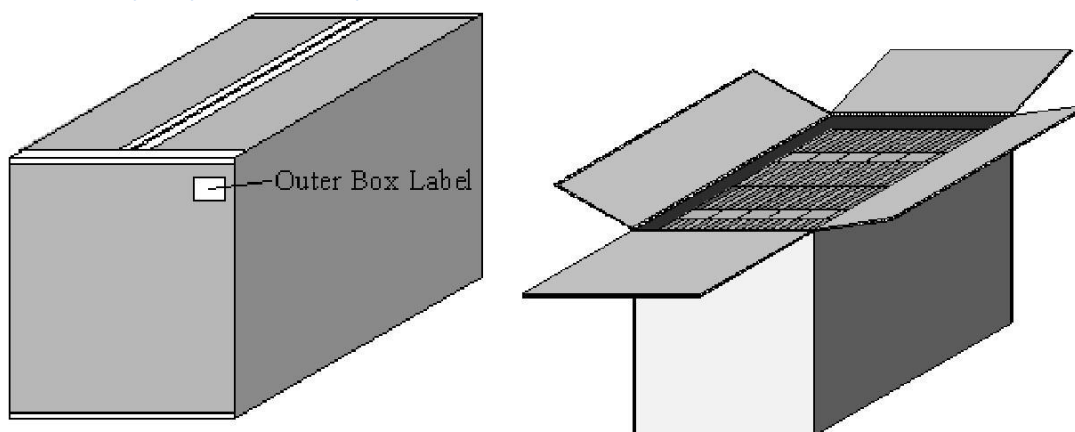
Package Dimensions of Reel



Package Box



- Capacity 5 or 10 reels per box (内箱容量: 5 或 10 卷)



Label

- Capacity 40 or 60 reels per box (外箱容量: 40 或 60 卷)

Caution

1. Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
2. Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
3. Die slug is to be soldered.
4. When soldering, do not put stress on the LEDs during heating.
5. After soldering, do not warp the circuit board.

Notes on Lightning PCT Series soldering:

1. Recommend to use reflow machine.
2. Recommend to use heating plate soldering.
3. Manual soldering is not recommended.

Notes on reflow process:

1. To confirm whether the actual temperature curve in the reflow soldering conditions comply with recommended conditions. LEDs are guaranteed for one time reflow.
2. During reflow process do not apply force on LED active area.
3. After reflow process, PCB board should be cooled down before packing or storage.

Precaution for use

Storage

1. Before opening the package: The LED should be kept at 30°C or less and 90%RH or less.
2. After opening the package: The LED's floor life is 168Hrs under 30°C or less and 60%RH or less. If unused LED remain, it should be stored in moisture proof packages JEDEC (MSL 3).
3. If the moisture absorbent material(silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions:
Baking treatment: 60±5°C for 24 hours.